SPECIFICATION FOR APPROVAL

MODEL NO: HM4522P-423-G

CATALOGUE

- 1. SCOPE
- MODEL NO.
- 3. ELECTRICAL CHARACTERISTICS
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- 3.2 Output Impedance
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- 12. LIST AND STRUCTURE OF MATERIALS

1. SCOPE	This specification shall be applied to electret condenser microphone(ECM)
2. MODEL NO.	HM4522P-423-G
3 ELECTRICAL CHARACTE	ERISTICS
Temp.	20° ± 2
Room Humidity	65% ± 5

NO.

Parameter

Symbol

Condition

Limits

Unit

Min.

Center

Max.

1

Sensitivity: S f=1KHZ,S.P.L=1Pa,0dB=1V/Pa-45-42-32 dB

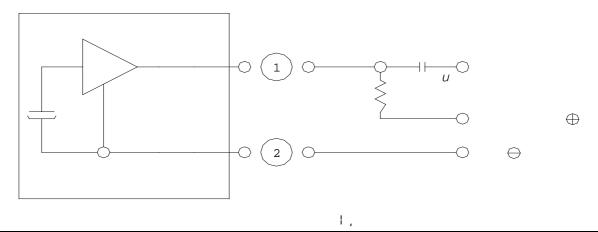
Output impedance: Zout f=1 kHz $2.2~\text{K}\Omega$

Current Consumption: Idds Vcc=2.0V, $RL=2.2K\Omega$ 150 500 UA

Signal to Noise Ratio: S/N f=1 KHz , S.P.L=1Pa 60 dB Decreasing Voltage: S-VS Vcc=2.0V to 1.5V -3 dB

Operating Voltage: 1-10V Maximum input S.P.L: 110 dB

4.MEASUREMENT CIRCUIT



5. TYPICAL FREQUENCY RESPONSE CURVE (FAR FIELD)

Far Field Measurement Condition

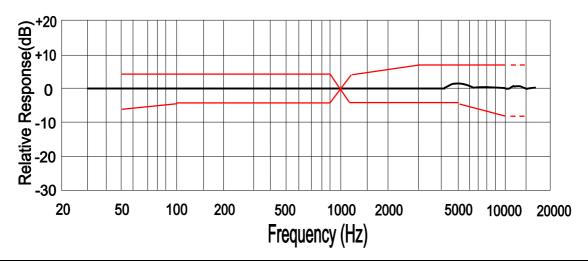
Temperature $20^{\circ} \pm 2$

Bias Voltage 2.0V (with 2.2K Ω series resistor 2.2K Ω Ohm)

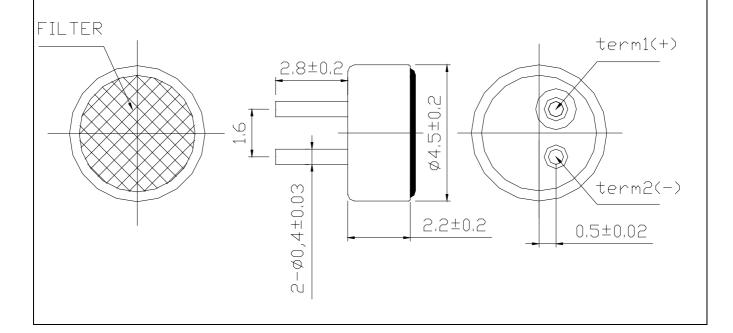
Acoustic stimulus :1Pa (94Db SPL at 1 KHZ) at 50cm from the loud-speaker.

The loud-speaker must be calibrated to make a flat frequency response input signal

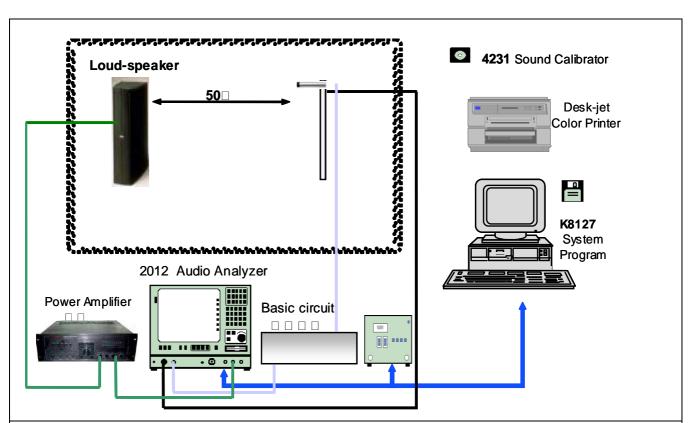
Position: The frequency response of microphone unit measured at 50cm from the loud-speaker



6.DIMENSIONAL DRAWING



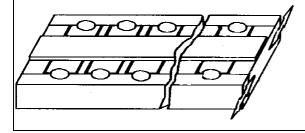
7.RELIABILITY TEST			
7.1 VIBRATION TEST	1 minute frequency from 10Hz to 55Hz, amplitude 1.52mm, the vibration in three directions tes 2 hours, the sensitivity deviation range of ± 3dB		
7.2 DROP TEST	Three directions with the regular packaging of free fall from 1 meter at the concrete floor, the sensitivity range of \pm 3dB deviation from the		
7.3 TEMPERATURE	(The measurement to be of the control of the contr	72 hours ,sensitivity to be within ±3dB from initial sensitivity done after 3 hours of conditioning at room temperature r 72hours,sensitivity to be within ±3dB from initial sensitivity one after 3 hours of conditioning at room temperature	
7.4 HUMIDITY TEST	from initial sensitivity	and 90 relative humidity for 72 hours ,sensitivity to be within ±3dB done after 3 hours of conditioning at room temperature)	
7.5 TESTCONDITION	StandardTestCondition: a Judgement Test Condition:)Temperature:+15□~+35□ b)Humidity:45%-75% c)Pressure:86 kPa -106kPa a) Temperature:(20±2)□ b) Humidity:60%-70% c) Pressure:86 kPa -106kPa	
8 TEMPERATURE CON	DITIONS		
8.1 STORAGE TEMPERATURE		-20°- +70°	
8.2 OPERATING TEMPERATURE		-20°- +70°	
9.MEASUREMENT SYS	TEM		



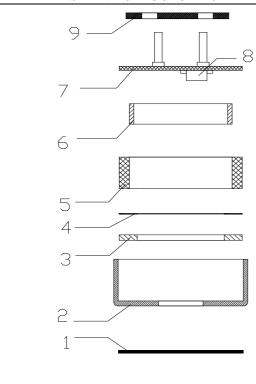
10.REGARDING THE SOLDERING OPERATION

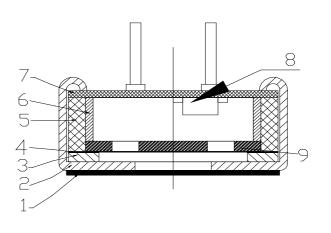
Every ECM contains a FET with microphone boby. This FET is easy to damageable from excessive heat and electrical shock. Proper attention for the soldering work is required same as followings.

- 1 -Recommend to use 15W 17W ceramic soldering iron and apply 270 ±10 temperature range
- 2 -Soldering should be accomplished within 2 seconds at each terminal so as not to be overheated.
- 3 -ECM shall be soldered fixed on the metal block(heat sink)which has the higher radiation effects. Heat sink shall contact with each of ECM.
- 4 -The pin hole soldering shall be avoided.
- 5 -E.C.M may easily destroyed by the static electricity, and the countermeasure for eliminating the static electricity (the ground for soldering copper, for work table and for human body) shall be executed.



12. LIST AND STRUCTURE OF MATERIALS





No. Part name

1 □□□ FELT

 $2 \square \square$ Case

 $3 \square \square$ Diaphragm

4 □□ Spacer

5 □□ Housping Chamber

6 □□ Copper ring

7 □□□ P.C.B

8 □ □ FET

9 □□ Back plate